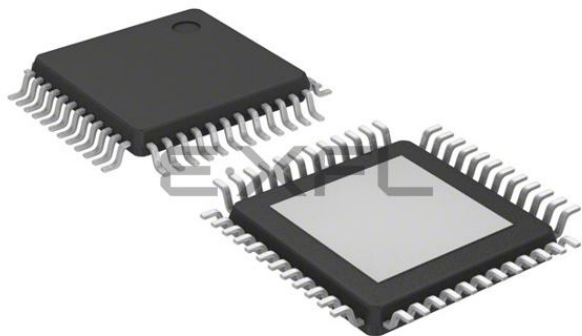




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	XCore
Core Size	32-Bit 8-Core
Speed	400MIPS
Connectivity	Configurable
Peripherals	-
Number of I/O	28
Program Memory Size	64KB (16K x 32)
Program Memory Type	SRAM
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP Exposed Pad
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xs1-l8a-64-tq48-c4

1 xCORE Multicore Microcontrollers

The XS1-L Series is a comprehensive range of 32-bit multicore microcontrollers that brings the low latency and timing determinism of the xCORE architecture to mainstream embedded applications. Unlike conventional microcontrollers, xCORE multicore microcontrollers execute multiple real-time tasks simultaneously and communicate between tasks using a high speed network. Because xCORE multicore microcontrollers are completely deterministic, you can write software to implement functions that traditionally require dedicated hardware.

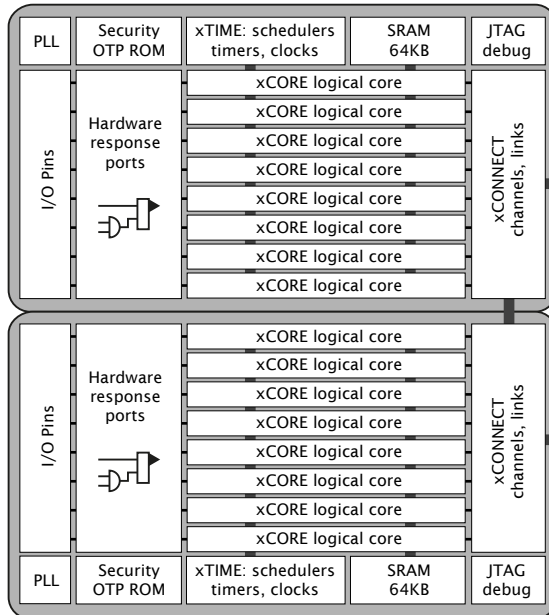


Figure 1:
XS1-L Series:
4-16 core
devices

Key features of the XS1-L8A-64-TQ48 include:

- ▶ **Tiles:** Devices consist of one or more xCORE tiles. Each tile contains between four and eight 32-bit xCOREs with highly integrated I/O and on-chip memory.
- ▶ **Logical cores** Each logical core can execute tasks such as computational code, DSP code, control software (including logic decisions and executing a state machine) or software that handles I/O. Section [5.1](#)
- ▶ **xTIME scheduler** The xTIME scheduler performs functions similar to an RTOS, in hardware. It services and synchronizes events in a core, so there is no requirement for interrupt handler routines. The xTIME scheduler triggers cores on events generated by hardware resources such as the I/O pins, communication channels and timers. Once triggered, a core runs independently and concurrently to other cores, until it pauses to wait for more events. Section [5.2](#)

4 Signal Description

This section lists the signals and I/O pins available on the XS1-L8A-64-TQ48. The device provides a combination of 1bit, 4bit, 8bit and 16bit ports, as well as wider ports that are fully or partially (gray) bonded out. All pins of a port provide either output or input, but signals in different directions cannot be mapped onto the same port.

Pins may have one or more of the following properties:

- PD/PU: The IO pin a weak pull-down or pull-up resistor. On GPIO pins this resistor can be enabled.
- ST: The IO pin has a Schmitt Trigger on its input.

Power pins (4)			
Signal	Function	Type	Properties
GND	Digital ground	GND	
PLL_AVDD	Analog PLL power	PWR	
VDD	Digital tile power	PWR	
VDDIO	Digital I/O power	PWR	

Clocks pins (2)			
Signal	Function	Type	Properties
CLK	PLL reference clock	Input	PD, ST
MODE[3:0]	Boot mode select	Input	PU, ST

JTAG pins (6)			
Signal	Function	Type	Properties
RST_N	Global reset input	Input	PU, ST
TCK	Test clock	Input	PU, ST
TDI	Test data input	Input	PU, ST
TDO	Test data output	Output	PD, OT
TMS	Test mode select	Input	PU, ST
TRST_N	Test reset input	Input	PU, ST

I/O pins (28)			
Signal	Function	Type	Properties
X0D00	1A ⁰	I/O	PD _S , R _S
X0D01	1B ⁰	I/O	PD _S , R _S
X0D10	1C ⁰	I/O	PD _S , R _S
X0D11	1D ⁰	I/O	PD _S , R _S
X0D12	1E ⁰	I/O	PD _S , R _U
X0D13	XLB _{out} ⁴ 1F ⁰	I/O	PD _S , R _U
X0D14	XLB _{out} ³ 4C ⁰ 8B ⁰ 16A ⁸ 32A ²⁸	I/O	PD _S , R _U
X0D15	XLB _{out} ² 4C ¹ 8B ¹ 16A ⁹ 32A ²⁹	I/O	PD _S , R _U

(continued)

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a “secure island” with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (see §7).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
	21..15	General purpose software accessible security register available to end-users.
	31..22	General purpose user programmable JTAG UserID code extension.

Figure 10:
Security
register
features

port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through `libotp` and `xburn`.

8.2 SRAM

The xCORE Tile integrates a single 64KBSRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

9 JTAG

The JTAG module can be used for loading programs, boundary scan testing, in-circuit source-level debugging and programming the OTP memory.

The JTAG chain structure is illustrated in Figure 11. Directly after reset, two TAP controllers are present in the JTAG chain: the boundary scan TAP and the chip TAP.

11.6 Clock

Figure 21:
Clock

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
f	Frequency	4.22	20	100	MHz	
SR	Slew rate	0.10			V/ns	
TJ(LT)	Long term jitter (pk-pk)			2	%	A
f(MAX)	Processor clock frequency (Speed Grade 4)			400	MHz	B
	Processor clock frequency (Speed Grade 5)			500	MHz	B

A Percentage of CLK period.

B Assumes typical tile and I/O voltages with nominal activity.

Further details can be found in the XS1-L Clock Frequency Control document, [X1433](#).

11.7 xCORE Tile I/O AC Characteristics

Figure 22:
I/O AC characteristics

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
T(XOVALID)	Input data valid window	8			ns	
T(XOINVALID)	Output data invalid window	9			ns	
T(XIFMAX)	Rate at which data can be sampled with respect to an external clock			60	MHz	

The input valid window parameter relates to the capability of the device to capture data input to the chip with respect to an external clock source. It is calculated as the sum of the input setup time and input hold time with respect to the external clock as measured at the pins. The output invalid window specifies the time for which an output is invalid with respect to the external clock. Note that these parameters are specified as a window rather than absolute numbers since the device provides functionality to delay the incoming clock with respect to the incoming data.

Information on interfacing to high-speed synchronous interfaces can be found in the XS1 Port I/O Timing document, [X5821](#).

11.8 xConnect Link Performance

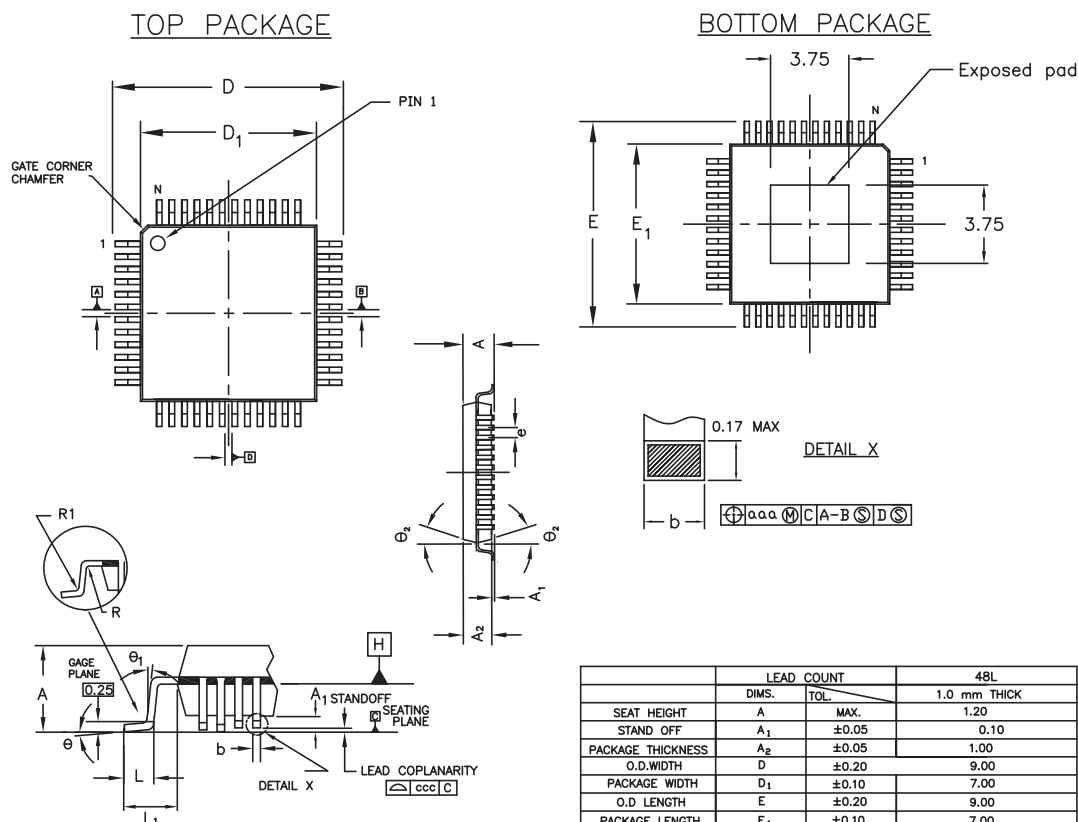
Figure 23:
Link performance

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
B(2blinkP)	2b link bandwidth (packetized)			87	MBit/s	A, B
B(5blinkP)	5b link bandwidth (packetized)			217	MBit/s	A, B
B(2blinkS)	2b link bandwidth (streaming)			100	MBit/s	B
B(5blinkS)	5b link bandwidth (streaming)			250	MBit/s	B

A Assumes 32-byte packet in 3-byte header mode. Actual performance depends on size of the header and payload.

B 7.5 ns symbol time.

12 Package Information

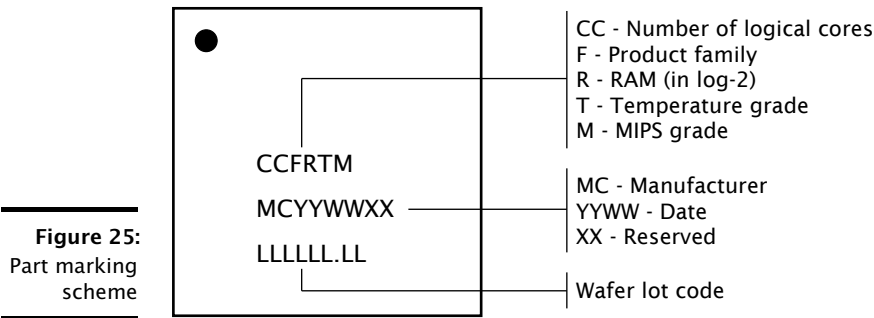


NOTES:

1. All dimensions in millimeters.
2. Dimension tolerances shall be $\pm 0.05\text{mm}$ unless otherwise specified.
3. Foot length 'L' is measured at gage plane 0.25mm above seating plane.
4. Dimension D₁ and E₁ are bottom package width and length and are measured at datum plane H.
5. Leadframe material: Eftec 64T Cu (or equivalent), 0.127mm (0.005") thick.

	LEAD COUNT		48L
	DIMS.	TOL.	1.0 mm THICK
SEAT HEIGHT	A	MAX.	1.20
STAND OFF	A ₁	± 0.05	0.10
PACKAGE THICKNESS	A ₂	± 0.05	1.00
O.D.WIDTH	D	± 0.20	9.00
PACKAGE WIDTH	D ₁	± 0.10	7.00
O.D LENGTH	E	± 0.20	9.00
PACKAGE LENGTH	E ₁	± 0.10	7.00
FOOT LENGTH	L	$+0.15/-0.10$	0.60
HALF FOOTPRINT	L ₁	REF	1.00
LEAD PITCH	e	TYPE	0.50
LEAD WIDTH	b	± 0.05	0.22
FOOT ANGLE	θ		0°-7°
VERTICAL ANGLE	θ_1		0° MIN.
	θ_2	$\pm 1^\circ$	12°
FIRST BEND	R	TYP	0.15
SECOND BEND	R1	± 0.05	0.15
	aaa	MAX.	0.08
COPLANARITY	ccc	MAX.	0.08
JEDEC REFERENCE DRAWING			MS-026
VARIATION DESIGNATOR			ABC

12.1 Part Marking



13 Ordering Information

Figure 26:
Orderable
part numbers

Product Code	Marking	Qualification	Speed Grade
XS1-L8A-64-TQ48-C4	8L6C4	Commercial	400 MIPS
XS1-L8A-64-TQ48-C5	8L6C5	Commercial	500 MIPS
XS1-L8A-64-TQ48-I4	8L6I4	Industrial	400 MIPS
XS1-L8A-64-TQ48-I5	8L6I5	Industrial	500 MIPS

0x03:
xCORE Tile
boot status

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		xCORE tile number on the switch.
15:9	RO	-	Reserved
8	RO		Set to 1 if boot from OTP is enabled.
7:0	RO		The boot mode pins MODE0, MODE1, ..., specifying the boot frequency, boot source, etc.

B.5 Security configuration: 0x05

Copy of the security register as read from OTP.

0x05:
Security
configuration

Bits	Perm	Init	Description
31:0	RO		Value.

B.6 Ring Oscillator Control: 0x06

There are four free-running oscillators that clock four counters. The oscillators can be started and stopped using this register. The counters should only be read when the ring oscillator is stopped. The counter values can be read using four subsequent registers. The ring oscillators are asynchronous to the xCORE tile clock and can be used as a source of random bits.

0x06:
Ring
Oscillator
Control

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Set to 1 to enable the xCORE tile ring oscillators
0	RW	0	Set to 1 to enable the peripheral ring oscillators

B.7 Ring Oscillator Value: 0x07

This register contains the current count of the xCORE Tile Cell ring oscillator. This value is not reset on a system reset.

0x07:
Ring
Oscillator
Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	-	Ring oscillator counter data.

0x11: Debug SPC	Bits	Perm	Init	Description
	31:0	DRW		Value.

B.13 Debug SSP: 0x12

This register contains the value of the SSP register when the debugger was called.

0x12: Debug SSP	Bits	Perm	Init	Description
	31:0	DRW		Value.

B.14 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

0x13: DGETREG operand 1	Bits	Perm	Init	Description
	31:8	RO	-	Reserved
	7:0	DRW		Thread number to be read

B.15 DGETREG operand 2: 0x14

Register number to be read by DGETREG

0x14: DGETREG operand 2	Bits	Perm	Init	Description
	31:5	RO	-	Reserved
	4:0	DRW		Register number to be read

B.16 Debug interrupt type: 0x15

Register that specifies what activated the debug interrupt.

B.19 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over JTAG. This is the same set of registers as the [Debug Scratch registers in the xCORE tile configuration](#).

0x20 .. 0x27:
Debug
scratch

Bits	Perm	Init	Description
31:0	DRW		Value.

B.20 Instruction breakpoint address: 0x30 .. 0x33

This register contains the address of the instruction breakpoint. If the PC matches this address, then a debug interrupt will be taken. There are four instruction breakpoints that are controlled individually.

0x30 .. 0x33:
Instruction
breakpoint
address

Bits	Perm	Init	Description
31:0	DRW		Value.

B.21 Instruction breakpoint control: 0x40 .. 0x43

This register controls which logical cores may take an instruction breakpoint, and under which condition.

0x40 .. 0x43:
Instruction
breakpoint
control

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core.
15:2	RO	-	Reserved
1	DRW	0	Set to 1 to cause an instruction breakpoint if the PC is not equal to the breakpoint address. By default, the breakpoint is triggered when the PC is equal to the breakpoint address.
0	DRW	0	When 1 the instruction breakpoint is enabled.

B.22 Data watchpoint address 1: 0x50 .. 0x53

This set of registers contains the first address for the four data watchpoints.

0x50 .. 0x53:
Data
watchpoint
address 1

Bits	Perm	Init	Description
31:0	DRW		Value.

B.23 Data watchpoint address 2: 0x60 .. 0x63

This set of registers contains the second address for the four data watchpoints.

0x60 .. 0x63:
Data
watchpoint
address 2

Bits	Perm	Init	Description
31:0	DRW		Value.

B.24 Data breakpoint control register: 0x70 .. 0x73

This set of registers controls each of the four data watchpoints.

0x70 .. 0x73:
Data
breakpoint
control
register

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core.
15:3	RO	-	Reserved
2	DRW	0	Set to 1 to enable breakpoints to be triggered on loads. Breakpoints always trigger on stores.
1	DRW	0	By default, data watchpoints trigger if memory in the range [Address1..Address2] is accessed (the range is inclusive of Address1 and Address2). If set to 1, data watchpoints trigger if memory outside the range (Address2..Address1) is accessed (the range is exclusive of Address2 and Address1).
0	DRW	0	When 1 the instruction breakpoint is enabled.

B.25 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.

C Tile Configuration

The xCORE Tile control registers can be accessed using configuration reads and writes (use `write_tile_config_reg(tileref, ...)` and `read_tile_config_reg(tileref, ...)` for reads and writes).

Number	Perm	Description
0x00	RO	Device identification
0x01	RO	xCORE Tile description 1
0x02	RO	xCORE Tile description 2
0x04	CRW	Control PSwitch permissions to debug registers
0x05	CRW	Cause debug interrupts
0x06	RW	xCORE Tile clock divider
0x07	RO	Security configuration
0x10 .. 0x13	RO	PLink status
0x20 .. 0x27	CRW	Debug scratch
0x40	RO	PC of logical core 0
0x41	RO	PC of logical core 1
0x42	RO	PC of logical core 2
0x43	RO	PC of logical core 3
0x44	RO	PC of logical core 4
0x45	RO	PC of logical core 5
0x46	RO	PC of logical core 6
0x47	RO	PC of logical core 7
0x60	RO	SR of logical core 0
0x61	RO	SR of logical core 1
0x62	RO	SR of logical core 2
0x63	RO	SR of logical core 3
0x64	RO	SR of logical core 4
0x65	RO	SR of logical core 5
0x66	RO	SR of logical core 6
0x67	RO	SR of logical core 7
0x80 .. 0x9F	RO	Chanend status

Figure 29:
Summary

C.1 Device identification: 0x00

0x00:
Device
identification

Bits	Perm	Init	Description
31:24	RO		Processor ID of this xCORE tile.
23:16	RO		Number of the node in which this xCORE tile is located.
15:8	RO		xCORE tile revision.
7:0	RO		xCORE tile version.

C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

0x01:
xCORE Tile
description 1

Bits	Perm	Init	Description
31:24	RO		Number of channel ends.
23:16	RO		Number of locks.
15:8	RO		Number of synchronisers.
7:0	RO	-	Reserved

C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02:
xCORE Tile
description 2

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:8	RO		Number of clock blocks.
7:0	RO		Number of timers.

C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.

0x04:
Control
PSwitch
permissions
to debug
registers

Bits	Perm	Init	Description
31:1	RO	-	Reserved
0	CRW		Set to 1 to restrict PSwitch access to all CRW marked registers to become read-only rather than read-write.

C.5 Cause debug interrupts: 0x05

This register can be used to raise a debug interrupt in this xCORE tile.

0x05:
Cause debug
interrupts

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RO	0	Set to 1 when the processor is in debug mode.
0	CRW	0	Set to 1 to request a debug interrupt on the processor.

C.6 xCORE Tile clock divider: 0x06

This register contains the value used to divide the PLL clock to create the xCORE tile clock. The divider is enabled under control of the [tile control register](#)

0x06:
xCORE Tile
clock divider

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7:0	RW		Value of the clock divider minus one.

C.7 Security configuration: 0x07

Copy of the security register as read from OTP.

0x07:
Security
configuration

Bits	Perm	Init	Description
31:0	RO		Value.

C.8 PLink status: 0x10 .. 0x13

Status of each of the four processor links; connecting the xCORE tile to the switch.

C.21 SR of logical core 3: 0x63

0x63:
SR of logical
core 3

Bits	Perm	Init	Description
31:0	RO		Value.

C.22 SR of logical core 4: 0x64

0x64:
SR of logical
core 4

Bits	Perm	Init	Description
31:0	RO		Value.

C.23 SR of logical core 5: 0x65

0x65:
SR of logical
core 5

Bits	Perm	Init	Description
31:0	RO		Value.

C.24 SR of logical core 6: 0x66

0x66:
SR of logical
core 6

Bits	Perm	Init	Description
31:0	RO		Value.

C.25 SR of logical core 7: 0x67

0x67:
SR of logical
core 7

Bits	Perm	Init	Description
31:0	RO		Value.

C.26 Chanend status: 0x80 .. 0x9F

These registers record the status of each channel-end on the tile.

0x80 .. 0x9F:
Chanend
status

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		00 - ChannelEnd, 01 - ERROR, 10 - PSCTL, 11 - Idle.
23:16	RO		Based on SRC_TARGET_TYPE value, it represents channelEnd ID or Idle status.
15:6	RO	-	Reserved
5:4	RO		Two-bit network identifier
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO	0	Set to 1 if the switch is routing data into the link, and if a route exists from another link.
0	RO	0	Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch.

0x06:
PLL settings

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:23	RW		OD: Output divider value The initial value depends on pins MODE0 and MODE1.
22:21	RO	-	Reserved
20:8	RW		F: Feedback multiplication ratio The initial value depends on pins MODE0 and MODE1.
7	RO	-	Reserved
6:0	RW		R: Oscillator input divider value The initial value depends on pins MODE0 and MODE1.

D.6 System switch clock divider: 0x07

Sets the ratio of the PLL clock and the switch clock.

0x07:
System
switch clock
divider

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	Switch clock divider. The PLL clock will be divided by this value plus one to derive the switch clock.

D.7 Reference clock: 0x08

Sets the ratio of the PLL clock and the reference clock used by the node.

0x08:
Reference
clock

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	3	Architecture reference clock divider. The PLL clock will be divided by this value plus one to derive the 100 MHz reference clock.

D.8 Directions 0-7: 0x0C

This register contains eight directions, for packets with a mismatch in bits 7..0 of the node-identifier. The direction in which a packet will be routed is governed by the most significant mismatching bit.

0x0C:
Directions
0-7

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose first mismatching bit is 7.
27:24	RW	0	The direction for packets whose first mismatching bit is 6.
23:20	RW	0	The direction for packets whose first mismatching bit is 5.
19:16	RW	0	The direction for packets whose first mismatching bit is 4.
15:12	RW	0	The direction for packets whose first mismatching bit is 3.
11:8	RW	0	The direction for packets whose first mismatching bit is 2.
7:4	RW	0	The direction for packets whose first mismatching bit is 1.
3:0	RW	0	The direction for packets whose first mismatching bit is 0.

D.9 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is governed by the most significant mismatching bit.

0x0D:
Directions
8-15

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose first mismatching bit is 15.
27:24	RW	0	The direction for packets whose first mismatching bit is 14.
23:20	RW	0	The direction for packets whose first mismatching bit is 13.
19:16	RW	0	The direction for packets whose first mismatching bit is 12.
15:12	RW	0	The direction for packets whose first mismatching bit is 11.
11:8	RW	0	The direction for packets whose first mismatching bit is 10.
7:4	RW	0	The direction for packets whose first mismatching bit is 9.
3:0	RW	0	The direction for packets whose first mismatching bit is 8.

D.10 DEBUG_N configuration: 0x10

Configures the behavior of the DEBUG_N pin.

0x10:
DEBUG_N
configuration

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Set to 1 to enable signals on DEBUG_N to generate DCALL on the core.
0	RW	0	When set to 1, the DEBUG_N wire will be pulled down when the node enters debug mode.

G.3 Full xSYS header

For a full xSYS header you will need to connect the pins as discussed in Section G.2, and then connect a 2-wire xCONNECT Link to the xSYS header. The links can be found in the Signal description table (Section 4): they are labelled XLA, XLB, etc in the function column. The 2-wire link comprises two inputs and outputs, labelled ${}^1_{out}$, ${}^0_{out}$, ${}^0_{in}$, and ${}^1_{in}$. For example, if you choose to use XLB of tile 0 for xSCOPE I/O, you need to connect up ${}^1_{out}$, ${}^0_{out}$, ${}^0_{in}$, ${}^1_{in}$ as follows:

- ▶ ${}^1_{out}$ (X0D16) to pin 6 of the xSYS header with a 33R series resistor close to the device.
- ▶ ${}^0_{out}$ (X0D17) to pin 10 of the xSYS header with a 33R series resistor close to the device.
- ▶ ${}^0_{in}$ (X0D18) to pin 14 of the xSYS header.
- ▶ ${}^1_{in}$ (X0D19) to pin 18 of the xSYS header.

H Schematics Design Check List

- ✓ This section is a checklist for use by schematics designers using the XS1-L8A-64-TQ48. Each of the following sections contains items to check for each design.

H.1 Power supplies

- ☐ VDDIO supply is within specification before the VDD (core) supply is turned on. Specifically, the VDDIO supply is within specification before VDD (core) reaches 0.4V (Section 10).
- ☐ The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V - 1.05V) within 10ms (Section 10).
- ☐ The VDD (core) supply is capable of supplying 300mA (Section 10).
- ☐ PLL_AVDD is filtered with a low pass filter, for example an RC filter, see Section 10

H.2 Power supply decoupling

- ☐ The design has multiple decoupling capacitors per supply, for example at least four 0402 or 0603 size surface mount capacitors of 100nF in value, per supply (Section 10).
- ☐ A bulk decoupling capacitor of at least 10uF is placed on each supply (Section 10).

H.3 Power on reset

- ☐ The RST_N and TRST_N pins are asserted (low) during or after power up. The device is not used until these resets have taken place. As the errata in the datasheets show, the internal pull-ups on these two pins can occasionally provide stronger than normal pull-up currents. For this reason, an RC type reset circuit is discouraged as behavior would be unpredictable. A voltage supervisor type reset device is recommended to guarantee a good reset. This also has the benefit of resetting the system should the relevant supply go out of specification.

H.4 Clock

- ☐ The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.

I PCB Layout Design Check List

- ☒ This section is a checklist for use by PCB designers using the XS1-L8A-64-TQ48. Each of the following sections contains items to check for each design.

I.1 Ground Plane

- ☐ Multiple vias (eg, 9) have been used to connect the center pad to the PCB ground plane. These minimize impedance and conduct heat away from the device. (Section [10.2](#)).
- ☐ Other than ground vias, there are no (or only a few) vias underneath or closely around the device. This create a good, solid, ground plane.

I.2 Power supply decoupling

- ☐ The decoupling capacitors are all placed close to a supply pin (Section [10](#)).
- ☐ The decoupling capacitors are spaced around the device (Section [10](#)).
- ☐ The ground side of each decoupling capacitor has a direct path back to the center ground of the device.

I.3 PLL_AVDD

- ☐ The PLL_AVDD filter (especially the capacitor) is placed close to the PLL_AVDD pin (Section [10](#)).